ATTORNEY DOCKET NO .: EMC03-07(03032)

Joint

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Declaration for Patent Application

As a named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name;

I believe I am the original, first and sole inventor (if only one name is listed) or an original, first and joint inventor (if plural names are listed in the signatory page(s) commencing at page 3 hereof) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

CIRCUIT BOARD PROCESSING TECHNIQUES USING SOLDER FUSING

the spe	ecification of which	(check one)							
[X]	is attached hereto	ο.							
[]	was filed on		as United States Application Serial No.:						
	and was amended on		(if applicable).						
includir			and understand the contents of t mendment referred to above.	he ab	ove-id	lenti	fied s	spec	ification,
defined	I acknowledge the in 37 C.F.R. §1.5		information which is known by m	e to b	e mat	eria	l to pa	atent	tability as
country any for	ent or inventor's ce	rtificate or 365(a) ited States of Am r patent or invento	fits under 35 U.S.C. §119(a)-(d) of any PCT international applicaterica, listed below and have also or's certificate, or of any PCT interprinciples or some content of the	ion w ident	hich d	esig elow	nated , by	d at I chec	least one king the box
		<u>Pri</u>	or Foreign Application(s)	Priority Not Claimed		Copy Filed?			
(Numb	er)	(Country)	(Day/Month/Year filed)]]	[]
(Numb	er)	(Country)	(Day/Month/Year filed)	[]	[]	[]
(Numb	er)	(Country)	(Day/Month/Year filed)	[]]]	[J
below.	I hereby claim the	e benefit under 35	U.S.C. §119(e) of any United St	ates p	orovisio	onal	appl	icatio	on(s) listed
(Applic	ation Number)		(Filing Date)		<u> </u>				
(Applic	ation Number)		(Filing Date)						

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose information known by me to be material to patentability as defined in 37 C.F.R. §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing date)	(Status: patented, pending, abandoned)							
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(Application Serial No.)	(Filing date)	(Status: patented, pending, abandoned)							
(Application Serial No.)	(Filing date)	(Status: patented, pending, abandoned)							
As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:									
	Barry W. Chapin, Esq. David E. Huang, Esq. Christine M. Kuta, Esq. Jeffrey J. Duquette, Esq. Christopher J. Lutz, Esq. Paul P. Kriz, Esq.	Reg. No. 39,934 Reg. No. 39,229 Reg. No. 38,001 Reg. No. 45,487 Reg. No. 44,883 Reg. No. 45,752							
of Chapin & Huang, L.L.C., Westborough Office Park, 1700 West Park Drive, Westborough, Massachusetts 01581 and									
	John M. Gunther Leanne J. Fitzgerald Krishnendu Gupta William R. Clark Penelope S. Wilson Robert Kevin Perkins	Reg. No. 26,175 Reg. No. 40,606 Reg. No. 37,977 Reg. No. 29,523 Reg. No. 29,751 Reg. No. 36,634							
of EMC Corporation, 176 South Street, Hopkinton, Massachusetts 01748.									
I also hereby grant additional Powers of Attorney to all of the above-identified attorney(s) and/or agent(s) to file and prosecute an international application under the Patent Cooperation Treaty based upon the above-identified application, including a power to meet all designated office requirements for designated states.									
Please send correspondence to: <u>David E. Huang, Esq.</u>									
Chapin & Huang, L.L.C. Westborough Office Park, 1700 West Park Drive, Westborough, MA 01581									

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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